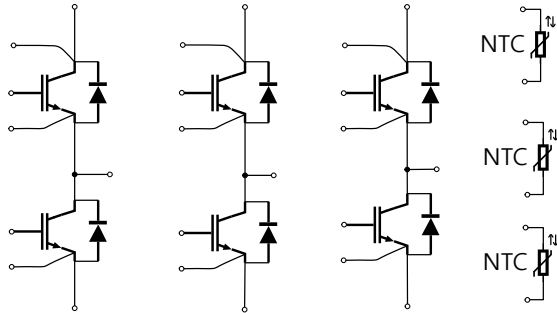


GCV400GX75FTH8TM

等效电路原理图

Equivalent Circuit Schematic



400A/750V

说明

翠展 IGBT 功率模块具有超低的导通损耗以及良好的短路可靠性。该产品是为混合动力汽车以及电动汽车等应用所设计。

典型应用

- 电机驱动器
- 纯电及混合动力系统
- 电动汽车

电气特性

- 低开关损耗
- 最大结温 175°C
- 正温度系数 V_{CEsat}
- 低 V_{CEsat}

机械特性

- 高功率循环和温度循环能力
- 集成 NTC 温度传感器
- 标准封装

Description

GRECON IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as hybrid and electric vehicle.

Typical Applications

- Motor drives
- EV&HEV
- Automotive Applications

Electrical Features

- Low Switching Losses
- Maximum junction temperature 175°C
- V_{CEsat} with positive Temperature Coefficient
- Low V_{CEsat}

Mechanical Features

- High Power and Thermal Cycling Capability
- Integrated NTC temperature sensor
- Standard Housing

IGBT

最大额定值 / Maximum Rated Values

Parameter	Symbol	Conditions	Value	Unit
集电极-发射极电压 Collector-emitter voltage	V_{CES}	$T_{vj}=25^{\circ}\text{C}$	750	V
集电极电流 Implemented collector current	I_{CN}		400	A
连续集电极直流电流 Continuous DC collector current	$I_{C\text{ nom}}$	$T_F=75^{\circ}\text{C}$, $T_{vj\text{ max}}=175^{\circ}\text{C}$	400	A
集电极重复峰值电流 Repetitive peak collector current	I_{CRM}	$t_p=1\text{ms}$	800	A
总功率损耗 Total power dissipation	P_{tot}	$T_F=75^{\circ}\text{C}$, $T_{vj\text{ max}}=175^{\circ}\text{C}$	1087	W
栅极-发射极峰值电压 Gate-emitter peak voltage	V_{GES}		± 20	V

特征值 / Characteristic Values

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
栅极阈值电压 Gate threshold voltage	V_{GEth}	$V_{GE}=V_{CE}$, $I_C=6.4\text{mA}$, $T_{vj}=25^{\circ}\text{C}$		6.20	6.8	V
栅极-发射极漏电流 Gate-emitter leakage current	I_{GES}	$V_{CE}=0\text{V}$, $V_{GE}=20\text{V}$, $T_{vj}=25^{\circ}\text{C}$			100	nA
集电极-发射极截止电流 Collector-emitter cut-off current	I_{CES}	$V_{CE}=750\text{V}$, $V_{GE}=0\text{V}$, $T_{vj}=25^{\circ}\text{C}$			1	mA
集电极-发射极饱和电压 Collector-emitter saturation voltage	$V_{CE\text{ sat}}$	$I_C=400\text{A}$, $V_{GE}=15\text{V}$, $T_{vj}=25^{\circ}\text{C}$		1.66	1.90	V
		$I_C=400\text{A}$, $V_{GE}=15\text{V}$, $T_{vj}=150^{\circ}\text{C}$		2.05		
		$I_C=400\text{A}$, $V_{GE}=15\text{V}$, $T_{vj}=175^{\circ}\text{C}$		2.14		
内部栅极电阻 Internal gate resistance	R_{gint}	$T_{vj}=25^{\circ}\text{C}$		0.30		Ω
栅极电荷 Gate charge	Q_G	$V_{GE}=-8\text{V}\sim+15\text{V}$, $V_{CE}=400\text{V}$		2.8		μC
输入电容 Input capacitance	C_{ies}	$V_{CE}=25\text{V}$, $V_{GE}=0\text{V}$, $f=100\text{kHz}$, $T_{vj}=25^{\circ}\text{C}$		34.4		nF
输出电容 Output capacitance	C_{oes}			1.39		
反向传输电容 Reverse transfer capacitance	C_{res}			0.23		

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
开通延迟时间（电感负载） Turn-on delay time , inductive load	$t_{d\ on}$	$I_c=400A, V_{CE}=400V$ $R_{gon}=2.2\Omega, R_{goff}=10\Omega$ $V_{GE}=-8V/+15V$ $di/dt_{on}=6945A/us$ $dv/dt_{off}=6600V/us$ $T_{vj}=25^\circ C$		51.1		ns
上升时间（电感负载） Rise time , inductive load	t_r			48.8		
关断延迟时间（电感负载） Turn-off delay time , inductive load	$t_{d\ off}$			430.5		
下降时间（电感负载） Fall time , inductive load	t_f			57.5		
开通损耗能量（每脉冲） Turn-on energy loss per pulse	E_{on}	$I_c=400A, V_{CE}=400V$ $R_{gon}=2.2\Omega, R_{goff}=10\Omega$ $V_{GE}=-8V/+15V$ $di/dt_{on}=6100A/us$ $dv/dt_{off}=6000V/us$ $T_{vj}=150^\circ C$		16.7		mJ
关断损耗能量（每脉冲） Turn-off energy loss per pulse	E_{off}			7.1		
开通延迟时间（电感负载） Turn-on delay time , inductive load	$t_{d\ on}$			45.8		
上升时间（电感负载） Rise time , inductive load	t_r			58.2		
关断延迟时间（电感负载） Turn-off delay time , inductive load	$t_{d\ off}$	$I_c=400A, V_{CE}=400V$ $R_{gon}=2.2\Omega, R_{goff}=10\Omega$ $V_{GE}=-8V/+15V$ $di/dt_{on}=6100A/us$ $dv/dt_{off}=6000V/us$ $T_{vj}=150^\circ C$		431.3		ns
下降时间（电感负载） Fall time , inductive load	t_f			86.7		
开通损耗能量（每脉冲） Turn-on energy loss per pulse	E_{on}			22.2		
关断损耗能量（每脉冲） Turn-off energy loss per pulse	E_{off}			10.3		
开通延迟时间（电感负载） Turn-on delay time , inductive load	$t_{d\ on}$	$I_c=400A, V_{CE}=400V$ $R_{gon}=2.2\Omega, R_{goff}=10\Omega$ $V_{GE}=-8V/+15V$ $di/dt_{on}=6050A/us$ $dv/dt_{off}=5700V/us$ $T_{vj}=175^\circ C$		46.9		ns
上升时间（电感负载） Rise time , inductive load	t_r			58.6		
关断延迟时间（电感负载） Turn-off delay time , inductive load	$t_{d\ off}$			425.2		
下降时间（电感负载） Fall time , inductive load	t_f			87.5		
开通损耗能量（每脉冲） Turn-on energy loss per pulse	E_{on}	$T_{vj}=175^\circ C$		22.5		mJ
关断损耗能量（每脉冲） Turn-off energy loss per pulse	E_{off}			11.2		

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
短路数据 SC data	I _{SC}	t _p ≤8us, V _{GE} =15V, V _{ce} =400V, V _{CEM} ≤750V, T _{vj} =25°C		1400		A
		t _p ≤6us, V _{GE} =15V, V _{ce} =400V, V _{CEM} ≤750V, T _{vj} =150°C		1320		A
结-流体热阻 Thermal resistance, junction to fluid	R _{thJF}	每个 IGBT / per IGBT △V/△t=10L/min, T _F =25°C		0.092		K/W
在开关状态下温度 Temperature under switching conditions	T _{vj op}		-40		150	°C

Diode

最大额定值 / Maximum Ratings

Parameter	Symbol	Conditions	Value	Unit
反向重复峰值电压 Repetitive peak reverse voltage	V_{RRM}	$T_{vj}=25^{\circ}\text{C}$	750	V
正向电流 Implemented forward current	I_{FN}		400	A
连续正向直流电流 Continuous DC forward current	I_F		400	A
正向重复峰值电流 Repetitive peak forward current	I_{FRM}	$t_p=1\text{ms}$	800	A

特征值 / Characteristic Values

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
正向电压 Forward voltage	V_F	$I_F=400\text{A}$, $V_{GE}=0\text{V}$, $T_{vj}=25^{\circ}\text{C}$		1.56		V
		$I_F=400\text{A}$, $V_{GE}=0\text{V}$, $T_{vj}=150^{\circ}\text{C}$		1.66		
		$I_F=400\text{A}$, $V_{GE}=0\text{V}$, $T_{vj}=175^{\circ}\text{C}$		1.65		
恢复电荷 Recovered charge	Q_{rr}	$I_F=400\text{A}$, $V_R=400\text{V}$ $-di_F/dt=6610\text{A/us}$ $T_{vj}=25^{\circ}\text{C}$		28.7		μC
反向恢复峰值电流 Peak reverse recovery current	I_{RM}			273		A
反向恢复损耗（每脉冲） Reverse recovery energy	E_{rec}			3.6		mJ
恢复电荷 Recovered charge	Q_{rr}	$I_F=400\text{A}$, $V_R=400\text{V}$ $-di_F/dt=5640\text{A/us}$ $T_{vj}=150^{\circ}\text{C}$		50.2		μC
反向恢复峰值电流 Peak reverse recovery current	I_{RM}			291		A
反向恢复损耗（每脉冲） Reverse recovery energy	E_{rec}			9.6		mJ
恢复电荷 Recovered charge	Q_{rr}	$I_F=400\text{A}$, $V_R=400\text{V}$ $-di_F/dt=5790\text{A/us}$ $T_{vj}=175^{\circ}\text{C}$		51.3		μC
反向恢复峰值电流 Peak reverse recovery current	I_{RM}			294		A
反向恢复损耗（每脉冲） Reverse recovery energy	E_{rec}			10.5		mJ
结-流体热阻 Thermal resistance, junction to fluid	R_{thJF}	每个二极管 / per Diode $\Delta V/\Delta t=10\text{L/min}$, $T_F=25^{\circ}\text{C}$		0.128		K/W
在开关状态下温度 Temperature under switching conditions	$T_{vj\text{ op}}$		-40		150	$^{\circ}\text{C}$

负温度系数热敏电阻 / NTC-Thermistor

特征值 / Characteristic Values

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
额定电阻值 Rated resistance	R ₂₅			5		kΩ
R100 偏差 Deviation of R100	ΔR/R	T _c =100°C, R ₁₀₀ =493.3Ω	-5		5	%
耗散功率 Power dissipation	P ₂₅				20	mW
B-值 B-value	B _{25/50}	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15K))]$		3380		K

模块 / Module

特征值（除非另有说明，否则 T_c=25°C）

Characteristic Values (T_c=25°C unless otherwise specified)

Parameter	Symbol	Conditions	Value			Unit
			Min	Typ	Max	
绝缘电压 Isolation voltage	V _{isol}	RMS,t=1min, f=50Hz	2500			V
最大结温 Maximum junction temperature	T _{jmax}				175	°C
在开关状态下温度 Operating junction temperature	T _{vj op}		-40		150	°C
储存温度 Storage temperature	T _{stg}		-40		125	°C
杂散电感（模块） Stray inductance module	L _{CE}			9		nH
模块引线电阻,端子-芯片 Module lead resistance,terminals-chip	R _{CC'+EE'}	T _F =25°C, 每个开关/per switch		1.00		mΩ
模块安装扭矩 Mounting torque for module mounting	M	M4 螺丝（底板到散热器） Screw M4 baseplate to heatsink	1.80	2.00	2.20	N.m
		Screw EJOT Delta PCB to frame	0.45	0.50	0.55	
模块重量 / Weight of module	G			530		g

电气特性（曲线） / Electrical Characteristics (curves)

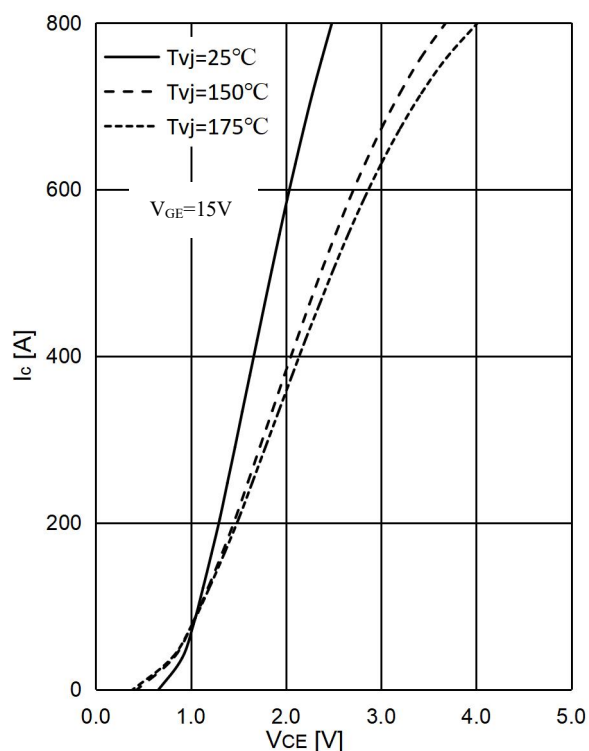


图 1 . IGBT 输出特性

Fig 1. IGBT Output Characteristic

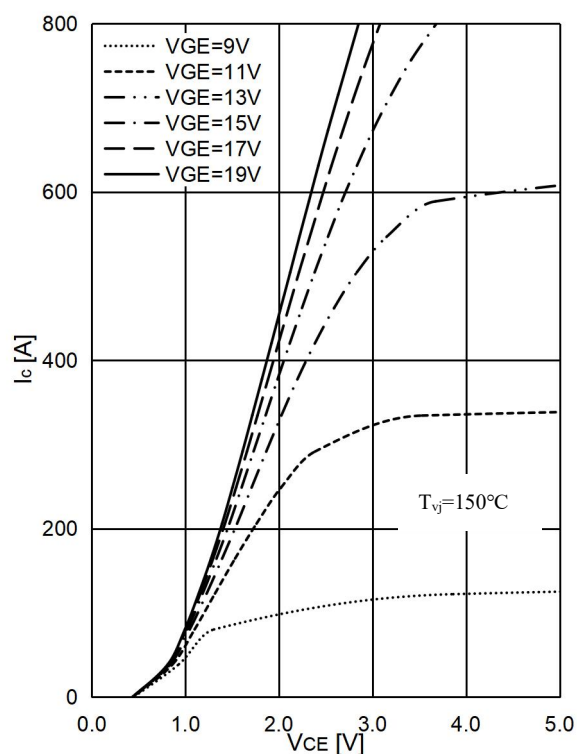


图 2 . IGBT 输出特性

Fig 2. IGBT Output Characteristic

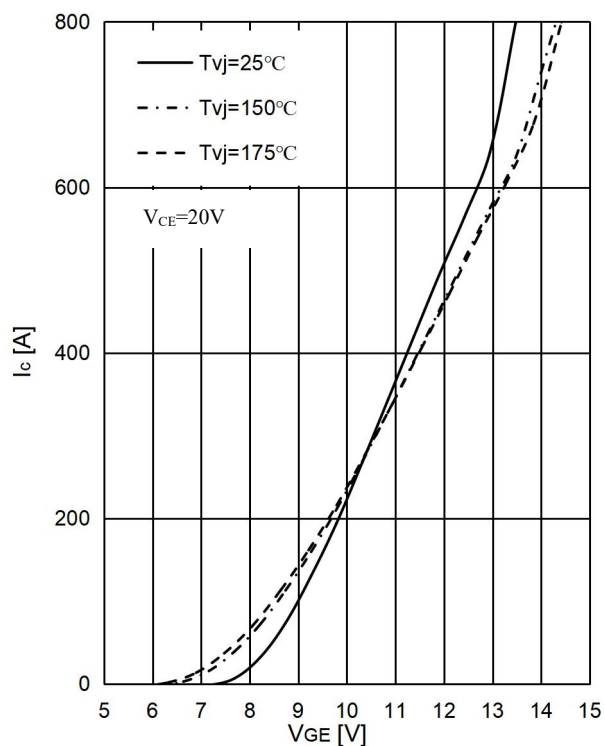


图 3 . IGBT 转移特性

Fig 3. IGBT Transfer Characteristic

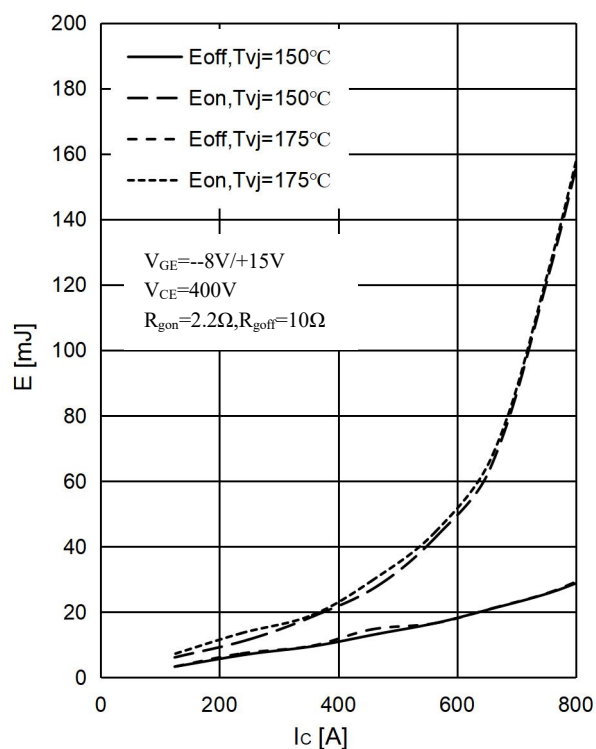


图 4 . IGBT 开关损耗-集电极电流

Fig 4. IGBT Switching Loss E_{on} & E_{off} vs. I_c

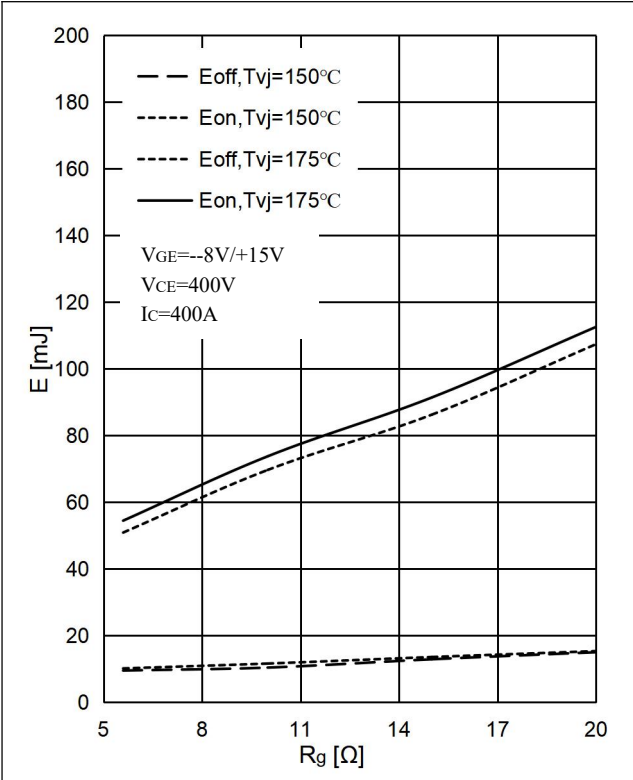


图 5 . IGBT 开关损耗-栅极电阻
Fig 5. IGBT Switching Loss E_{on} & E_{off} vs. R_g

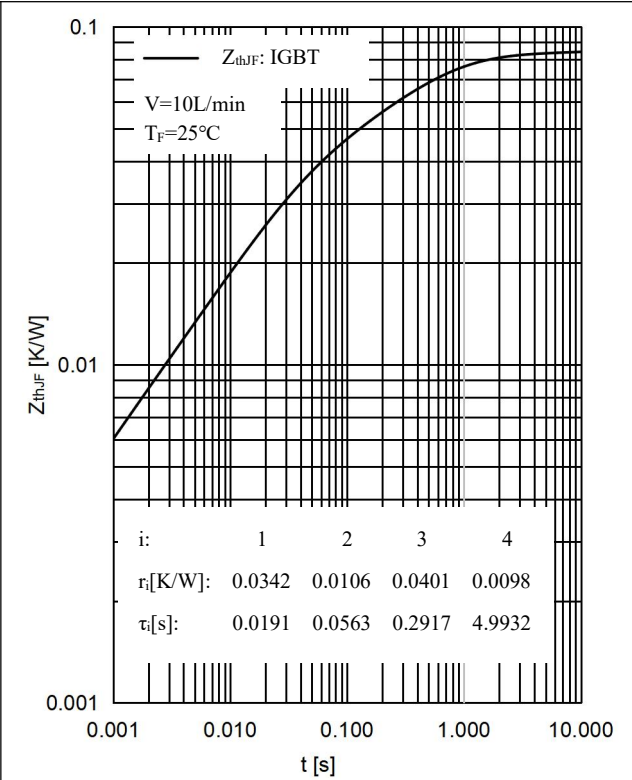


图 6 . IGBT 瞬态热阻抗
Fig 6. IGBT Transient thermal impedance

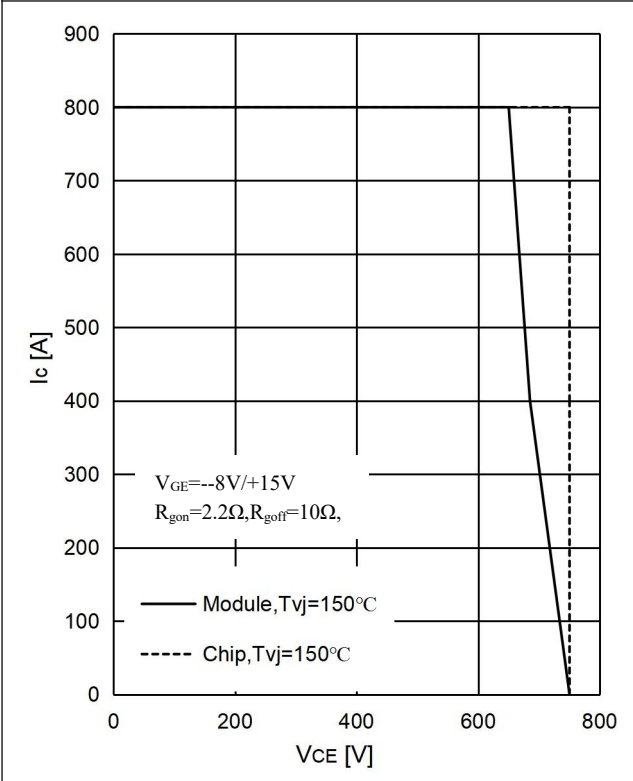


图 7 . IGBT 反偏安全工作区
Fig 7. IGBT RBSOA

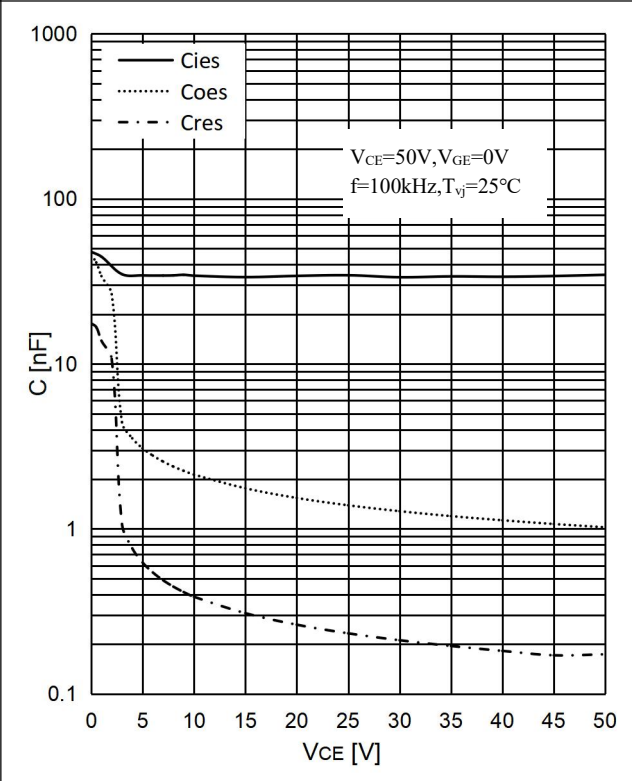


图 8 . IGBT 电容特性
Fig 8. IGBT Capacity Characteristic

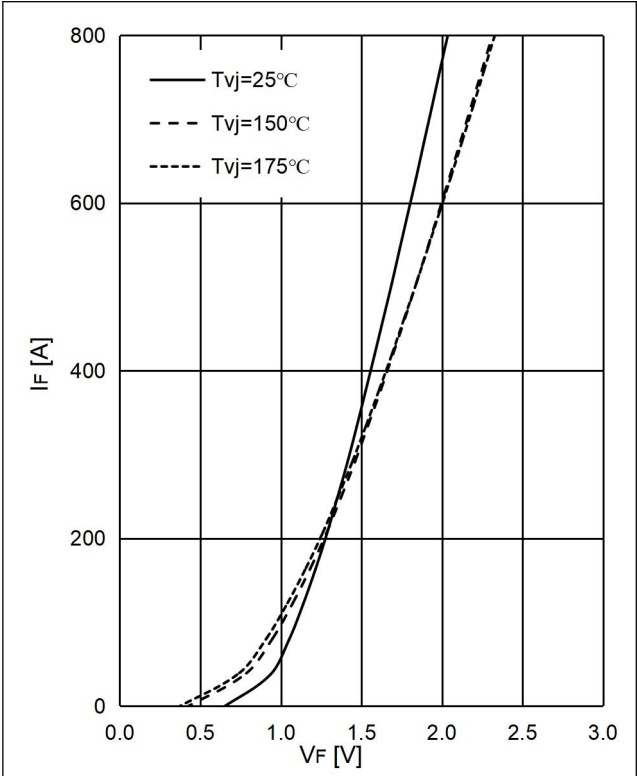


图 9 . 二极管 正向偏压特性
Fig 9. Diode Forward characteristic

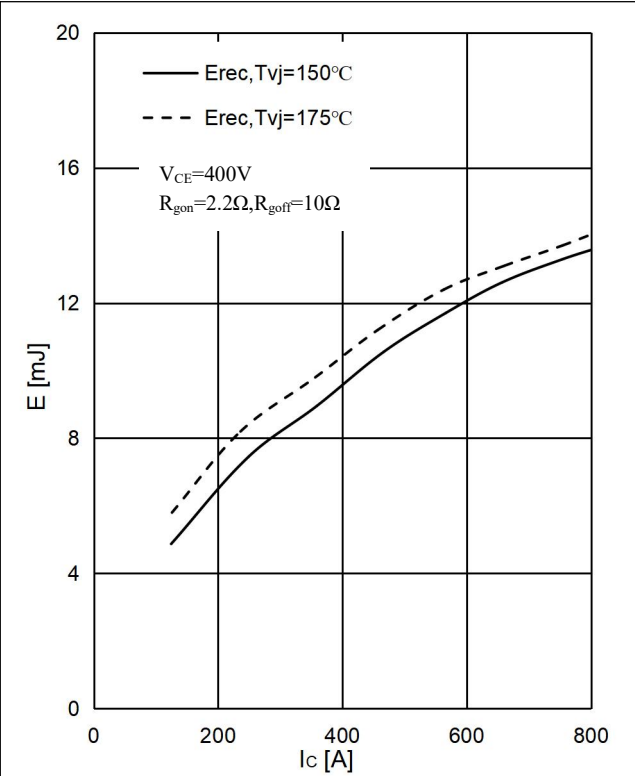


图 10 . 二极管 开关损耗-正向电流
Fig 10. Diode Switching Loss E_{rec} vs. I_F

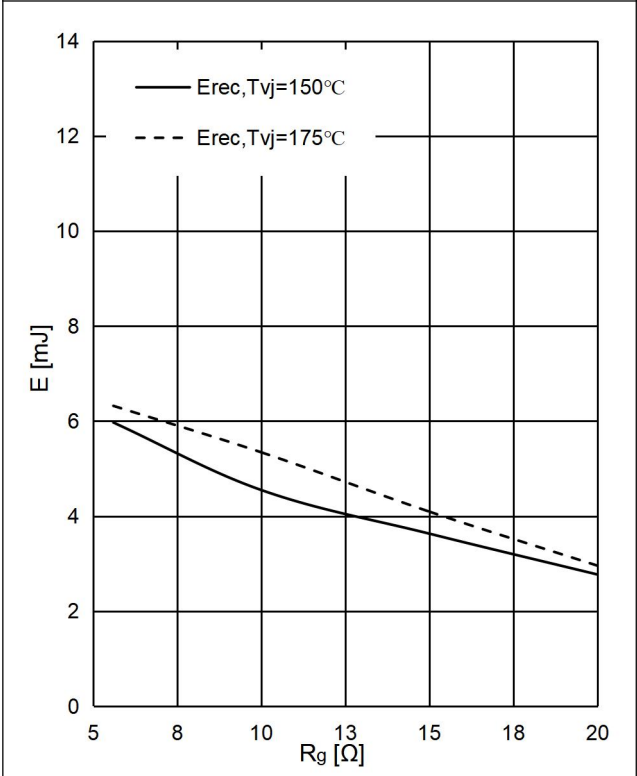


图 11 . 二极管 开关损耗-栅极电阻
Fig 11. Diode Switching Loss E_{rec} vs. R_g

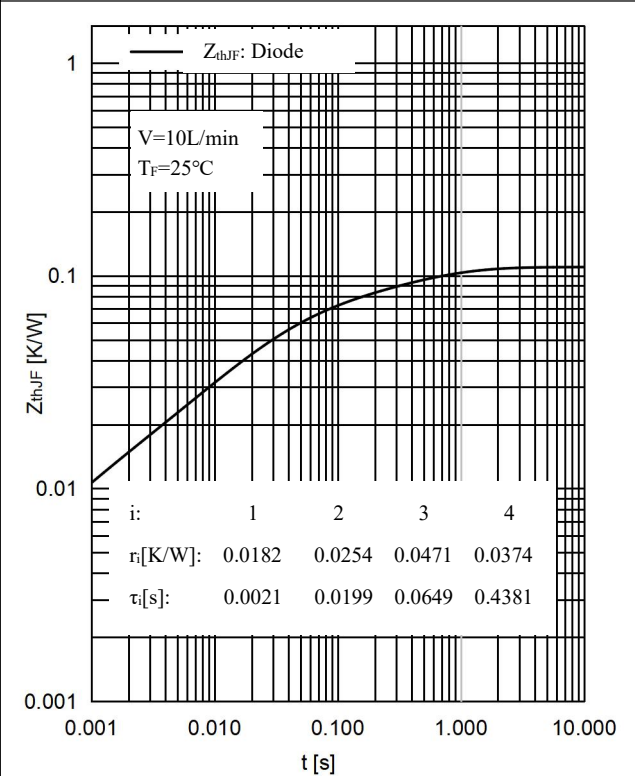
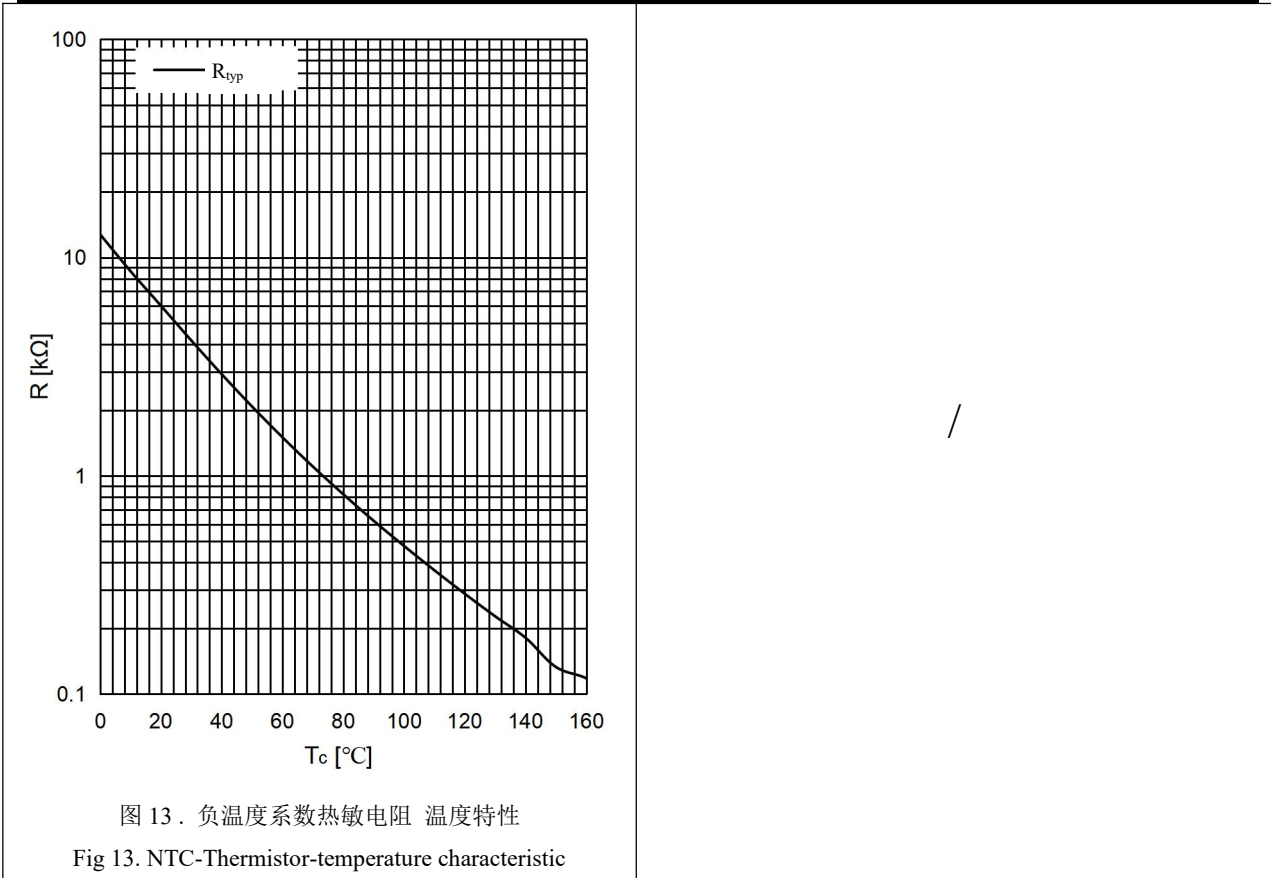
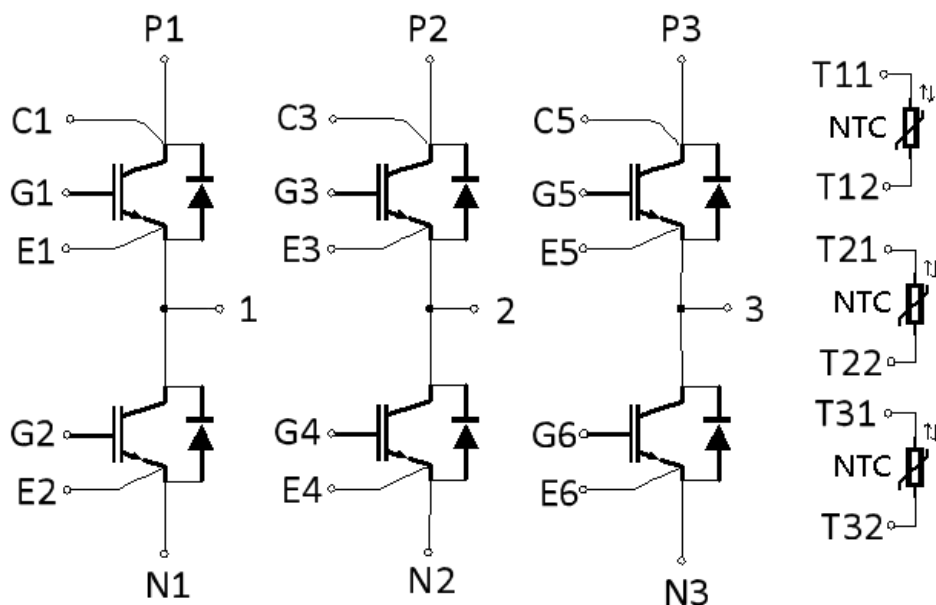


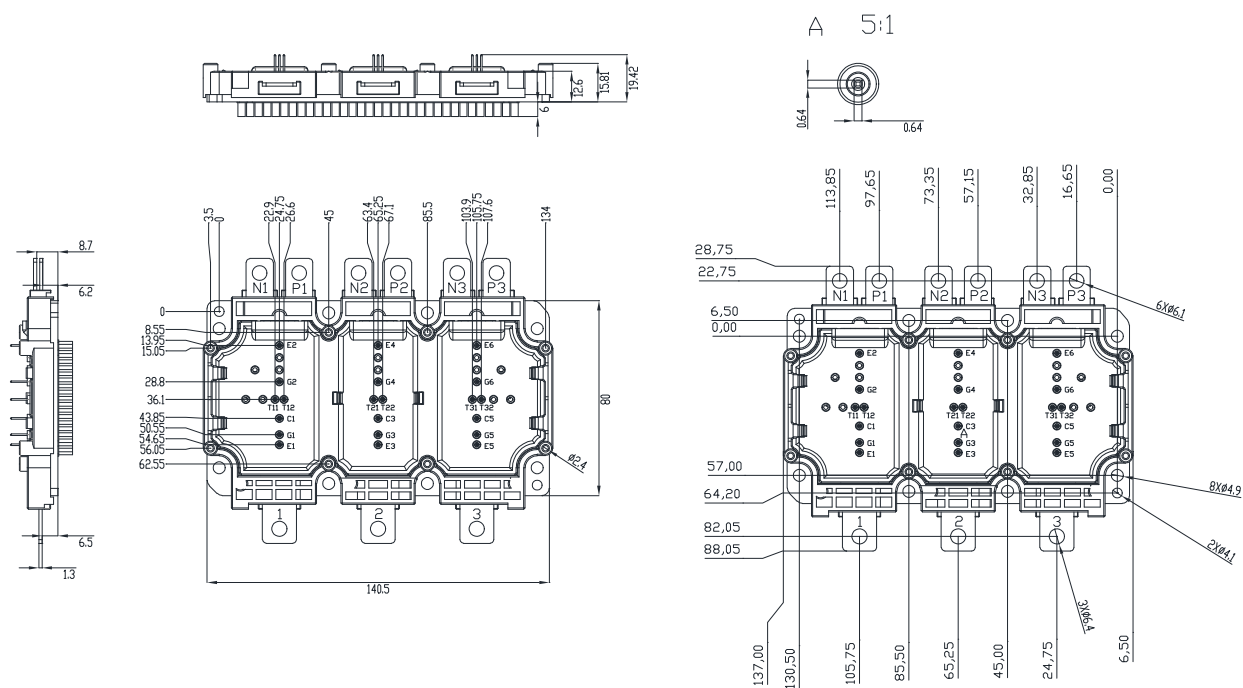
图 12 . 二极管 瞬态热阻抗
Fig 12. Diode Transient thermal impedance



电路图 / Circuit Diagram



封装尺寸 / Package Dimensions



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Should you intend to use the Product in aviation applications, in health or live endangering or life support applications, please notify. Please note, that for any such applications we urgently recommend:

- to perform joint Risk and Quality Assessments;
- the conclusion of Quality Agreements;
- to establish joint measures of an ongoing product survey, and that we may make delivery depended on the realization of any such measures.

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